

Electronic Patent Application Fee Transmittal

Application Number:	10599661			
Filing Date:				
Title of Invention:	Palladium-plated Lead Finishing Structure For Semiconductor Part And Method Of Producing Semiconductor Device			
First Named Inventor:	Kazumitsu Seki			
Filer:	Joseph A. Calvaruso			
Attorney Docket Number:	17314018			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
National Stage Fee	1631	1	300	300
National Stage Search - all other cases	1632	1	500	500
National Stage Exam - all other cases	1633	1	200	200
Pages:				
Claims:				
Independent claims in excess of 3	1614	1	200	200
Miscellaneous-Filing:				
Petition:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1200